# imall

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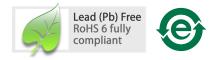
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# ASMT- Mx2x / ASMT- MxEx Moonstone<sup>TM</sup> 3W Power LED Light Source

# **Data Sheet**





# Description

The Moonstone<sup>™</sup> 3W Power LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The exposed pad design has excellent heat transfer from the package to the motherboard.

The Cool White Power LED is available in various color temperature ranging from 4000K to 10000K and Warm White Power LED ranging from 2600K to 4000K.

The low profile package design is suitable for a wide variety of applications especially where height is a constraint.

The package is compatible with reflow soldering. This will give more freedom and flexibility to the light source designer.

# **Applications**

- Sign backlight
- Safety, exit and emergency sign lightings
- Specialty lighting such as task lighting and reading lights
- Retail display
- Commercial lighting
- Accent or marker lightings, strip or step lightings
- Portable lightings, bicycle head lamp, torch lights.
- Decorative lighting
- Architectural lighting
- Pathway lighting
- Street lighting
- Pedestrian street lighting
- Tunnel lighting

#### Features

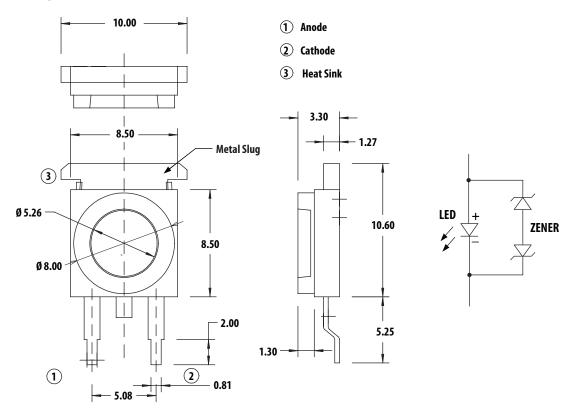
- Available in Cool White & Warm White color
- Energy efficient
- Exposed pad for excellent heat transfer
- Suitable for reflow soldering process
- High current operation
- Long operation life
- Wide viewing angle
- Silicone encapsulation
- Non-ESD sensitive (threshold > 16KV)
- MSL 4 products
- Available in both electrically isolated and non-isolated metal heat slug

### **Specifications**

- InGaN Technology
- 4.3 V (max) at 700 mA
- 120° viewing angle



# **Package Dimensions**



Notes:

- 1. All dimensions are in millimeters.
- 2. Unless otherwise stated, the tolerance for dimension is  $\pm 0.1$  mm.
- 3. Metal slug is connected to anode for electrically non-isolated option.

		Luminous Flux, $\Phi_{ m v}^{[1,2]}$ (lm)		Test Current	Die	Electrically	
Color	Part Number	Min.	Тур.	Max.	(mA)	Technology	Isolated Metal Slug
Cool White	ASMT-MW20	124	145	161	700	InGaN	No
	ASMT-MW22						Yes
Warm White	ASMT-MY20	95	125	161	700	InGaN	No
	ASMT-MY22						Yes
Cool White Diffused	ASMT-MWE0	95	125	161	700	InGaN	No
	ASMT-MWE2						Yes
Warm White Diffused	ASMT-MYE0	95	110	161	700	InGaN	No
	ASMT-MYE2						Yes

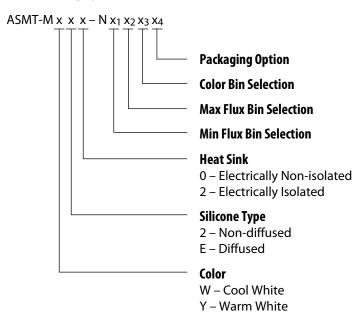
# Device Selection Guide ( $T_J = 25^{\circ}C$ )

Notes:

1.  $\Phi_V$  is the total luminous flux output as measured with an integrating sphere at 25ms mono pulse condition.

2. Flux tolerance is  $\pm 10\%$ .

# Part Numbering System



Note:

1. Please refer to Page 7 for selection details.

#### **Absolute Maximum Ratings**

Parameter	ASMT-Mx2x / ASMT-MxEx	Units
DC Forward Current <sup>[1]</sup>	700	mA
Peak Pulsing Current <sup>[2]</sup>	1000	mA
Power Dissipation	3010	mW
Reverse Voltage	5	V
LED Junction Temperature	125	°C
Operating Metal Slug Temperature Range at 700mA	-40 to +95	°C
Storage Temperature Range	-40 to +120	°C
Soldering Temperature	Refer to Figure	28

Note:

1. Derate linearly based on Figure 6.

2. Pulse condition: duty factor = 10%, Frequency = 1 kHz.

# Optical Characteristics at 700 mA ( $T_J = 25^{\circ}C$ )

		Correlated CCT (Kelvin	Color Temperature, )	Viewing Angle $2\theta_{1/2}$ <sup>[1]</sup> (°)	Luminous Efficiency (Im/W)	
Part Number	Color	Min.	Max.	Тур.	Тур.	
ASMT-MW20 ASMT-MW22	Cool White	4000	10000	120	52	
ASMT-MY20 ASMT-MY22	Warm White	2600	4000	120	45	
ASMT-MWE0 ASMT-MWE2	Cool White Diffused	4000	10000	120	45	
ASMT-MYE0 ASMT-MYE2	Warm White Diffused	2600	4000	120	41	

Notes:

1.  $\theta_{1/2}$  is the off-axis angle where the luminous intensity is 1/2 the peak intensity.

# Electrical Characteristic at 700 mA ( $T_J = 25^{\circ}C$ )

	Forward Voltage, V <sub>F</sub> (Volts) at I <sub>F</sub> = 700 mA			Thermal Resistance, R⊖ <sub>j-ms</sub> (°C/W) <sup>[1]</sup>	Temperature Coefficient of Forward Voltage (mV/°C), $\Delta V_{ m F}/\Delta T_{ m J}$
Dice Type	Min.	Тур.	Max.	Тур.	Тур.
InGaN	3.6	4.0	4.3	10	-1.5 to -3.5

Note:

1.  $R\theta_{j-ms}$  is the Thermal Resistance from LED junction to metal slug.

# Typical Characteristic at 350 mA ( $T_J = 25^{\circ}C$ )

		Luminous Flux, $\Phi_{ m V}$ (Im)	Forward Voltage <i>,</i> V <sub>F</sub> (Volts)
Part Number	Color	Тур.	Тур.
ASMT-MW20 ASMT-MW22	Cool White	80	3.6
ASMT-MY20 ASMT-MY22	Warm White	70	3.6
ASMT-MWE0 ASMT-MWE2	Cool White Diffused	70	3.6
ASMT-MYE0 ASMT-MYE2	Warm White Diffused	65	3.6

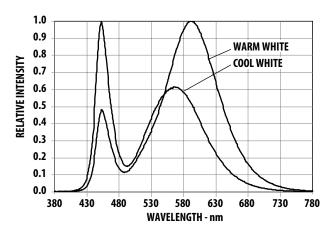


Figure 1. Relative Intensity vs. Wavelength.

FORWARD CURRENT - mA

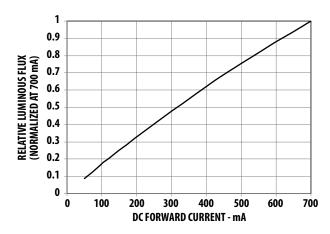


Figure 2. Relative Luminous Flux vs. Forward Current.

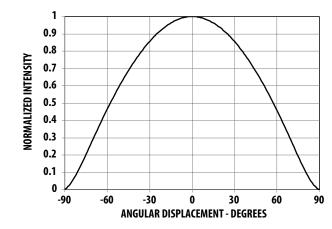
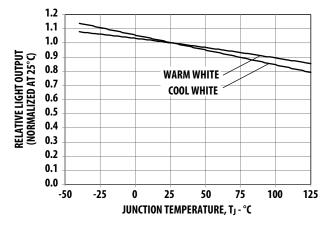


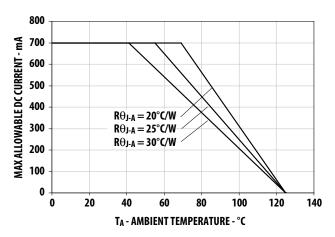
Figure 3. Forward Current vs. Forward Voltage.



**FORWARD VOLTAGE - V** 

Figure 5. Relative Light Output vs. Junction Temperature.

Figure 4. Radiation Pattern.



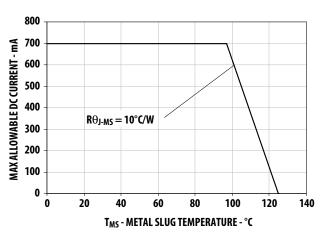


Figure 6. Maximum Forward Current vs. Ambient Temperature. Derated based on TJMAX = 125°C, R $\theta_{J-A}$  = 20°C/W, 25°C/W and 30°C/W.

Figure 7. Maximum Forward Current vs. Metal Slug Temperature. Derated based on TJMAX =  $125^{\circ}$ C,  $R\theta_{J-MS} = 10^{\circ}$ C/W.

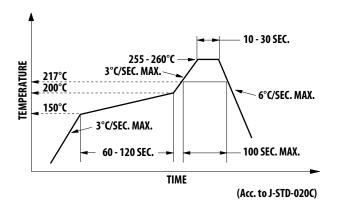
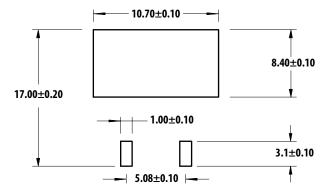
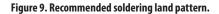


Figure 8. Recommended Reflow Soldering.





# **Option Selection Details**

# ASMT-Mxxx – N x<sub>1</sub> x<sub>2</sub> x<sub>3</sub> x<sub>4</sub>

x<sub>1</sub> – Minimum Flux Bin

- x<sub>2</sub> Maximum Flux Bin x<sub>3</sub> – Color Bin Selection
- x<sub>4</sub> Packaging Option

### Flux Bin Limit [x<sub>1</sub> x<sub>2</sub>]

Luminous Flux (Im) at I <sub>F</sub> = 700mA				
Min.	Max.			
73.0	95.0			
95.0	124.0			
124.0	161.0			
	Min. 73.0 95.0	Min.         Max.           73.0         95.0           95.0         124.0		

Tolerance for each bin limits is  $\pm 10\%$ .

# Color Bin Selections [x<sub>3</sub>]

Individual reel will contain parts from one full bin only.

#### **Cool White**

0	Full Distribution
А	A only
В	Bonly
С	C only
D	D only
E	Eonly
F	Fonly
G	G only
Н	H only
L	A and G only
Μ	B and H only
Ν	A and C only
Р	B and D only
Q	E and C only
R	F and D only
S	G and H only
U	E and F only
W	C and D only
Z	A and B only
1	A, B, C and D only
2	G, H, A and B only
4	C, D, E and F only

Warm White	
0	Full Distribution
А	A only
В	Bonly
С	C only
D	D only
E	E only
F	F only
Ν	A and C only
Р	B and D only
Q	E and C only
R	F and D only
U	E and F only
W	C and D only
Z	A and B only
V	D and E only
1	A, B, C and D only
4	C, D, E and F only

#### **Color Bin Limit**

Cool White	Color Limits (Chromaticity Coordinates)							
Bin A	X Y	0.367	0.362	0.329 0.345	0.329 0.369			
Bin B	X Y	0.362	0.356	0.329	0.329			
Bin C	X Y	0.329	0.329	0.305	0.301 0.342			
Bin D	X Y	0.329	0.329	0.311	0.305			
Bin E	X Y	0.303	0.307	0.283	0.274			
Bin F	X Y	0.307	0.311	0.290	0.283			
Bin G	X Y	0.388	0.379	0.362	0.367			
Bin H	X Y	0.379 0.383	0.369 0.343	0.356 0.330	0.362			

Warm White		Limits maticity Coo	rdinates)		
Bin A	Х	0.452	0.488	0.470	0.438
	Y	0.434	0.447	0.414	0.403
Bin B	Х	0.438	0.470	0.452	0.424
	Y	0.403	0.414	0.384	0.376
Bin C	Х	0.407	0.418	0.452	0.438
	Y	0.393	0.422	0.434	0.403
Bin D	Х	0.395	0.407	0.438	0.424
	Y	0.362	0.393	0.403	0.376
Bin E	Х	0.381	0.387	0.418	0.407
	Y	0.377	0.404	0.422	0.393
Bin F	Х	0.373	0.381	0.407	0.395
	Υ	0.349	0.377	0.393	0.362

Tolerance: ±0.01

Tolerance:  $\pm 0.01$ 

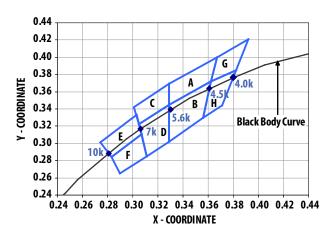


Figure 10a. Color bins (Cool White).

# Packaging Option [x<sub>4</sub>]

Selection	Option
0	Tube
1	Tape and Reel

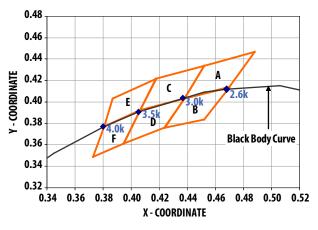


Figure 10b. Color bins (Warm White).

# Example

#### ASMT-MW20-NLNZ0

ASMT-MW20-Nx>	xx – Cool White, Electrically Non-isolated Heat Sink, Non-diffused
$X_1 = L$	– Minimum Flux Bin L
$X_2 = N$	– Maximum Flux Bin N
$X_3 = Z$	<ul> <li>Color Bin A and B only</li> </ul>
$X_4 = 0$	– Tube Option

# Packing Tube – Option 0

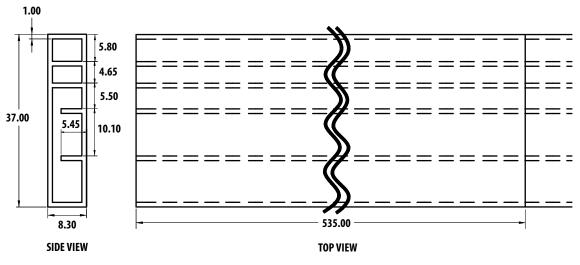
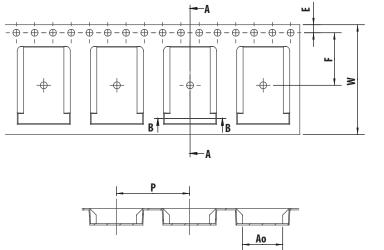
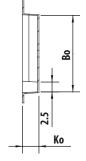


Figure 11. Tube dimensions

Tape & Reel – Option 1





**SECTION A** 

Dim	Value
A <sub>O</sub>	8.80±0.10
B <sub>O</sub>	16.45±0.10
Ko	3.60±0.1
E	1.75±0.10
F	11.50±0.10
W	24.0±0.10
Р	16.0±0.10
Q'ty/Reel	250 units
All dimensions in millimeters.	

SECTION B

Figure 12. Carrier tape dimensions

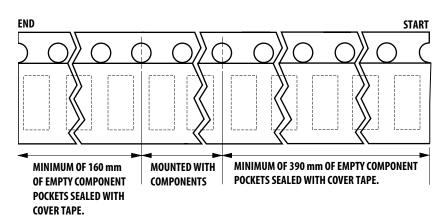
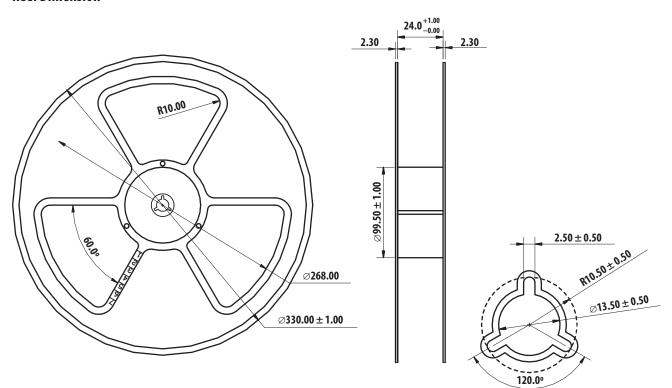


Figure 13. Carrier tape leader and trailer dimensions.



**Reel Dimension** 

Figure 14. Reel dimensions.

# **Handling Precaution**

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material, please do not press on the silicone or poke a sharp object onto the silicone. These might damage the product and cause premature failure. During assembly or handling, the unit should be held on the body only. Please refer to Avago Application Note AN 5288 for detail information.

# **Moisture Sensitivity**

This product is qualified as Moisture Sensitive Level 4 per Jedec J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling of Moisture Sensitive Surface Mount Devices for details.

A. Storage before use

- Unopen moisture barrier bag (MBB) can be stored at <40°C/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity indicator card (HIC) indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is not recommended to open the MBB prior to assembly (e.g. for IQC).

- B. Control after opening the MBB
  - The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
  - The LEDs must be kept at <30°C/60%RH at all time and all high temperature related process including soldering, curing or rework need to be completed within 72 hours.
- C. Control for unfinished reel
  - For any unused LEDs, they need to be stored in sealed MBB with desiccant or desiccator at <5%RH.</li>
- D. Control of assembly boards
  - If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure no LEDs have exceeded their floor life of 72 hours.
- E. Baking is required if
  - HIC "10%" indicator is not blue and "5%" indicator is pink.
  - The LEDs are exposed to condition of >30°C/60% RH at any time.
  - The LEDs floor life exceeded 72hrs.

Recommended baking condition:  $60\pm5^{\circ}C$  for 20hrs.

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